

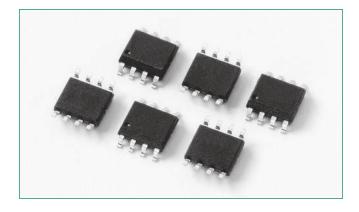
SP03-6 Series 6V 150A Diode Array











Description

This new broadband protection component from Littelfuse provides overvoltage protection for applications such as 10/100/1000 BaseT Ethernet, T3/E3 DS3 interfaces, ADSL2+, and VDSL2+. This new protector combines the TVS diode element with a diode rectifier bridge to provide both longitudinal and differential protection in one package. This innovative design results in a capacitive loading characteristic that is log-linear with respect to the signal voltage across the device. This reduces intermodulation (IM) distortion caused by a typical solid-state protection solution.

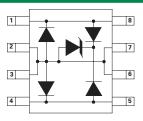
Agency Approvals

Agency	Agency File Number		
7U	E128662		

Features

- · RoHS-compliant and lead-
- SOIC-8 surface mount package (JEDEC MS-012)
- · Low insertion loss, loglinear capacitance
- Combined longitudinal and differential protection
- Clamping speed of nanoseconds
- UL Recognized compound meeting flammability rating V-0
- Lightning, 150A (8/20 as defined in IEC 61000-4-5 2nd Edition)
- · Low clamping voltage

Pinout



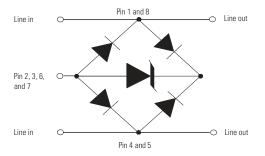
SOIC-8 (Top View)

Applications

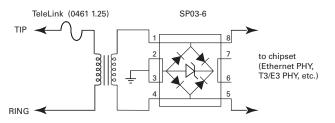
- T1/E1 Line cards
- T3/E3 and DS3 Interfaces
- STS-1 Interfaces

• 10/100/1000 BaseT Ethernet

Functional Block Diagram



Application Example



This schematic shows a high-speed data interface protection solution. The SP03-6 provides both metallic (differential) and longitudinal (common mode) protection from lightning induced surge events. Its surge rating is compatible with the intra-building surge requirements of Telcordia's GR-1089-CORE, and the Basic Level Recommendations of ITU K.20 and K.21. This component protects against both positive and negative induced surge events. The TeleLink fuse provides overcurrent protection for the long term 50/60 Hz power fault events.

Additional Information







Samples

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.



Absolute Maximum Ratings

Parameter	Rating	Units
Peak Pulse Current (8/20µs)	150	А
Peak Pulse Power (8/20µs)	2800	W
IEC 61000-4-2, Contact Discharge, (Level 4)	30	kV
IEC 61000-4-2, Air Discharge, (Level 4)	30	kV
IEC 61000-4-5, 2nd Edition (8/20)	100	А
Telcordia GR 1089 (Intra-Building) (2/10µs)	150	А
ITU K.20 (5/310μs)	40	А

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics $(T_{OP} = 25^{\circ}C)$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Stand-Off Voltage	V _{RWM}	-	-	-	6	V
Reverse Breakdown Voltage	V _{BR}	I _T = 1mA	6.8	-	-	V
Reverse Leakage Current	I _R	V _{RWM} = 6V, T= 25°C	-	-	25	μА
Clamping Voltage, Line-Ground	V _c	I _{pp} = 50A, t _p =8/20 μs	-	-	15	V
Clamping Voltage, Line-Ground	V _c	I _{pp} = 100A, t _p =8/20 μs	-	-	20	V
Junction Capacitance	C _j (Line-Ground)	Between I/O Pins and Ground $V_R=0V$, f= 1MHz	-	16	25	pF
	C _j (Line-Line)	Between I/O Pins V _R =0V, f= 1MHz	-	8	12	pF

Figure 1: Non-repetitive Peak Pulse Current vs. Pulse Time

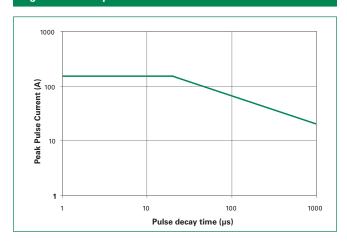


Figure 2: Current Derating Curve

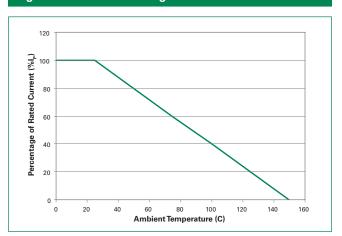




Figure 3: Pulse Waveform

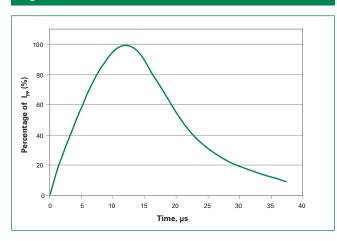


Figure 4: Clamping Voltage vs. Peak Pulse Current

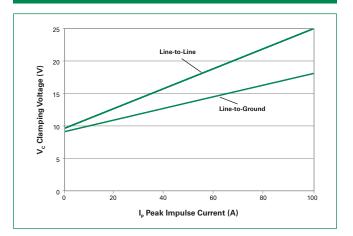


Figure 5: Capacitance vs. Reverse Voltage

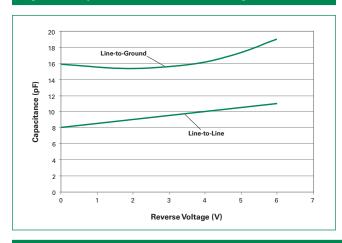
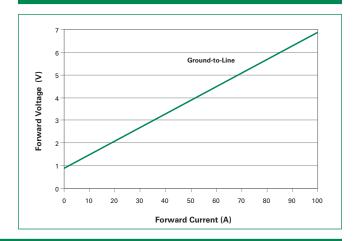
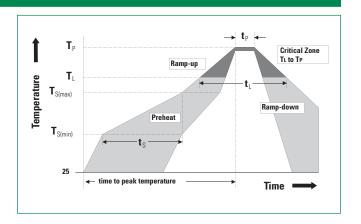


Figure 6: Forward Voltage vs. Forward Current



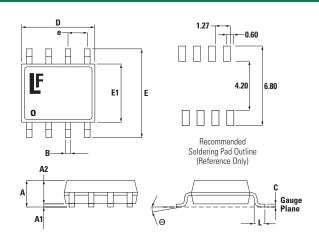
Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	- Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ran	3°C/second max		
T _{S(max)} to T _L -	3°C/second max		
Defless	- Temperature (T _L) (Liquidus)	217°C	
Reflow	- Temperature (t _L)	60 - 150 seconds	
Peak Temperature (T _P)		260 ^{+0/-5} °C	
Time withir	20 - 40 seconds		
Ramp-down	6°C/second max		
Time 25°C t	8 minutes Max.		
Do not exce	260°C		



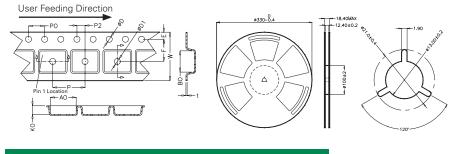


Package Dimensions — Mechanical Drawings and Recommended Solder Pad Outline



Package	SOIC				
Pins	8				
JEDEC	MS-012				
	Millin	Millimetres Inches			
	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A1	0.10	0.25	0.004	0.010	
A2	1.25	1.65	0.049	0.065	
В	0.31	0.51	0.012	0.020	
С	0.17	0.25	0.007	0.010	
D	4.80	5.00	0.189	0.197	
E	5.80	6.20	0.228	0.244	
E1	3.80	4.00	0.150	0.157	
е	1.27	1.27 BSC 0.050 BSC			
L	0.40	1.27	0.016	0.050	

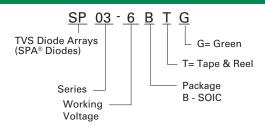
Embossed Carrier Tape & Reel Specification — SOIC Package



C= Location YYWW: Date Code

	Millimetres		In	ches
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	5.4	5.6	0.213	0.22
P2	1.95	2.05	0.077	0.081
D	1.5	1.6	0.059	0.063
D1	1.50) Min	0.059 Min	
P0	3.9	4.1	0.154	0.161
10P0	40.0 ± 0.20		1.574 ± 0.008	
w	11.9	12.1	0.468	0.476
Р	7.9	8.1	0.311	0.319
A0	6.3	6.5	0.248	0.256
В0	5.1	5.3	0.2	0.209
K0	2	2.2	0.079	0.087
t	0.30 ± 0.05 0.012 ± 0.002			± 0.002

Part Numbering System



A A A A **IF** SP03-6

Product Characteristics

Lead Plating	MatteTin			
Lead Material	Copper Alloy			
Lead Coplanarity	0.003 inches (0.08 mm)			
Substrate Material	Silicon			
Body Material	Molded			
Flammability	UL Recognized compound meeting flammability rating V-0			

Ordering Information

PIN 1-

Part Marking System

Part Number	Package	Marking	Min. Order Qty.
SP03-6BTG	SOIC Tape & Reel	SP03-6	2500

 H

- All dimensions are in millimeters
 Dimensions include solder plating.
 Dimensions are exclusive of mold flash & metal burr.
- Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
 Package surface matte finish VDI 11-13.

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at http://www.littelfuse.com/disclaimer-electronics.